



Integrated
Circuit
Systems, Inc.

ICS8302I-01

Low SKEW, 1-TO-2 LVCMOS / LVTTTL FANOUT BUFFER W/ COMPLEMENTARY OUTPUT

GENERAL DESCRIPTION

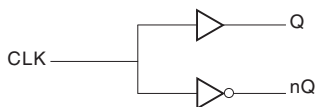


The ICS8302I-01 is a low skew, 1-to-2 LVCMOS/LVTTL Fanout Buffer w/Complementary Output and a member of the HiPerClockS™ family of High Performance Clock Solutions from ICS. The ICS8302I-01 has a single ended clock input. The single ended clock input accepts LVCMOS or LVTTTL input levels. The ICS8302I-01 is characterized at full 3.3V for input V_{DD} , and mixed 3.3V and 2.5V for output operating supply modes (V_{DDO}). Guaranteed output and part-to-part skew characteristics make the ICS8302I-01 ideal for clock distribution applications demanding well defined performance and repeatability.

FEATURES

- Complementary LVCMOS / LVTTTL output
- LVCMOS / LVTTTL clock input accepts LVCMOS or LVTTTL input levels
- Maximum output frequency: 250MHz
- Output skew: 165ps (maximum)
- Part-to-part skew: 800ps (maximum)
- Small 8 lead SOIC package saves board space
- Full 3.3V or 3.3V core/2.5V output supply modes
- -40°C to 85°C ambient operating temperature
- Available in both standard and lead-free compliant packages

BLOCK DIAGRAM



PIN ASSIGNMENT

V_{DDO}	1	8	Q
V_{DD}	2	7	GND
CLK	3	6	V_{DDO}
GND	4	5	nQ

ICS8302I-01
8-Lead SOIC

3.8mm x 4.8mm, x 1.47mm package body

M Package
Top View



TABLE 1. PIN DESCRIPTIONS

Number	Name	Type		Description
1, 6	V_{DDO}	Power		Output supply pins.
2	V_{DD}	Power		Power supply pin.
3	CLK	Input	Pulldown	LVCMOS / LVTTTL clock input.
4,7	GND	Power		Power supply ground.
5	nQ	Output		Complementary clock output. LVCMOS / LVTTTL interface levels.
8	Q	Output		Clock output. LVCMOS / LVTTTL interface levels.

NOTE: *Pulldown* refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C_{IN}	Input Capacitance			4		pF
C_{PD}	Power Dissipation Capacitance (per output)	$V_{DD}, V_{DDO} = 3.465V$		22		pF
		$V_{DD} = 3.465V, V_{DDO} = 2.625V$		16		pF
$R_{PULLDOWN}$	Input Pulldown Resistor			51		k Ω
R_{OUT}	Output Impedance		5	7	12	Ω



ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{DD}	4.6V
Inputs, V_I	-0.5V to $V_{DD} + 0.5V$
Outputs, V_O	-0.5V to $V_{DDO} + 0.5V$
Package Thermal Impedance, θ_{JA}	112.7°C/W (0 lfpm)
Storage Temperature, T_{STG}	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

TABLE 3A. POWER SUPPLY DC CHARACTERISTICS, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 3.3V \pm 5\%$ OR $2.5V \pm 5\%$, $T_A = -40^\circ\text{C}$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Power Supply Voltage		3.135	3.3	3.465	V
V_{DDO}	Output Power Supply Voltage		3.135	3.3	3.465	V
			2.375	2.5	2.625	V
I_{DD}	Power Supply Current				13	mA
I_{DDO}	Output Supply Current				4	mA

TABLE 3B. LVCMOS / LVTTTL DC CHARACTERISTICS, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 3.3V \pm 5\%$ OR $2.5V \pm 5\%$, $T_A = -40^\circ\text{C}$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage		2		$V_{DD} + 0.3$	V
V_{IL}	Input Low Voltage		-0.3		0.8	V
I_{IH}	Input High Current	CLK $V_{DD} = V_{IN} = 3.465V$			150	μA
I_{IL}	Input Low Current	CLK $V_{DD} = 3.465V, V_{IN} = 0V$	-5			μA
V_{OH}	Output High Voltage	$V_{DDO} = 3.465, 50\Omega$ to $V_{DDO}/2$	2.6			V
		$V_{DDO} = 3.465, I_{OH} = -100\mu\text{A}$	2.9			V
		$V_{DDO} = 2.625, 50\Omega$ to $V_{DDO}/2$	1.8			V
		$V_{DDO} = 2.625, I_{OH} = -100\mu\text{A}$	2.2			V
V_{OL}	Output Low Voltage	$V_{DDO} = 3.465, 50\Omega$ to $V_{DDO}/2$			0.5	V
		$V_{DDO} = 3.465, I_{OL} = 100\mu\text{A}$			0.2	V
		$V_{DDO} = 2.625, 50\Omega$ to $V_{DDO}/2$			0.5	V
		$V_{DDO} = 2.625, I_{OL} = 100\mu\text{A}$			0.2	V



TABLE 4A. AC CHARACTERISTICS, $V_{DD} = V_{DDO} = 3.3V \pm 5\%$, $T_A = -40^\circ\text{C}$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{MAX}	Output Frequency				250	MHz
tp_{LH}	Propagation Delay, Low-to-High; NOTE 1		1.8		2.7	ns
$tsk(o)$	Output Skew; NOTE 2, 4				165	ps
$tsk(pp)$	Part-to-Part Skew; NOTE 3, 4				800	ps
t_R / t_F	Output Rise/Fall Time	20% to 80%	300		800	ps
odc	Output Duty Cycle	$f \leq 133\text{MHz}$	45		55	%
		$133\text{MHz} < f \leq 250\text{MHz}$	40		60	%

NOTE 1: Measured from $V_{DD}/2$ of the input to $V_{DDO}/2$ of the output.

NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions. Measured at $V_{DDO}/2$.

NOTE 3: Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at $V_{DDO}/2$.

NOTE 4: This parameter is defined in accordance with JEDEC Standard 65.

TABLE 4B. AC CHARACTERISTICS, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 2.5V \pm 5\%$, $T_A = -40^\circ\text{C}$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{MAX}	Output Frequency				250	MHz
tp_{LH}	Propagation Delay, Low-to-High; NOTE 1		1.9		2.9	ns
$tsk(o)$	Output Skew; NOTE 2, 4				250	ps
$tsk(pp)$	Part-to-Part Skew; NOTE 3, 4				900	ps
t_R / t_F	Output Rise/Fall Time	20% to 80%	100		850	ps
odc	Output Duty Cycle	$f \leq 133\text{MHz}$	45		55	%
		$133\text{MHz} < f \leq 250\text{MHz}$	40		60	%

NOTE 1: Measured from $V_{DD}/2$ of the input to $V_{DDO}/2$ of the output.

NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions. Measured at $V_{DDO}/2$.

NOTE 3: Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at $V_{DDO}/2$.

NOTE 4: This parameter is defined in accordance with JEDEC Standard 65.

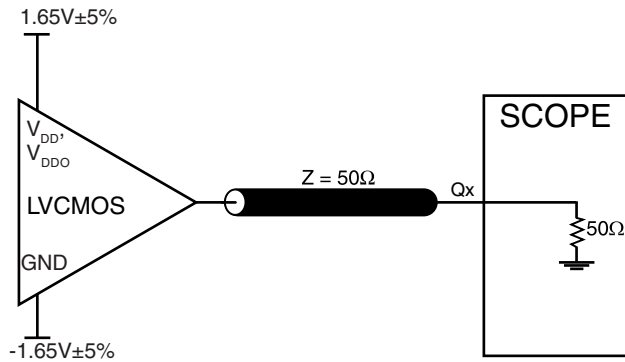


Integrated
Circuit
Systems, Inc.

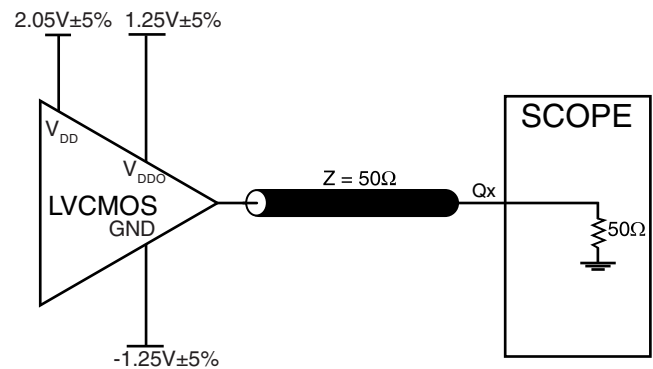
ICS8302I-01

Low SKEW, 1-TO-2 LVCMOS / LVTTTL
FANOUT BUFFER W/ COMPLEMENTARY OUTPUT

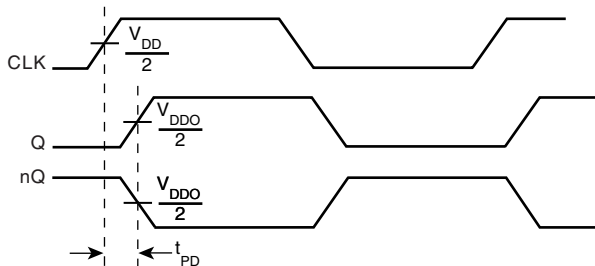
PARAMETER MEASUREMENT INFORMATION



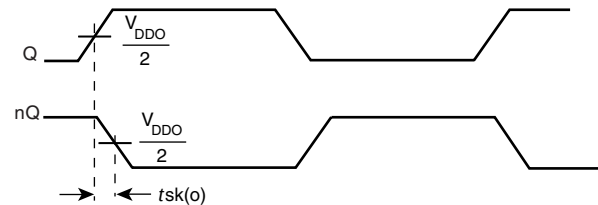
3.3V CORE/3.3V OUTPUT LOAD AC TEST CIRCUIT



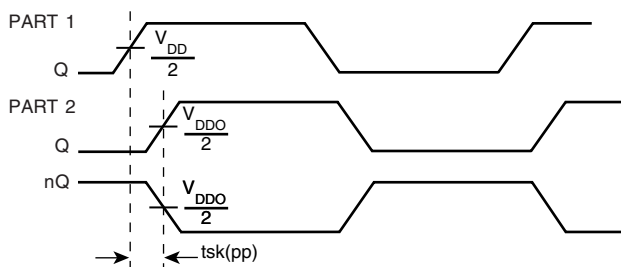
3.3V/2.5V OUTPUT LOAD AC TEST CIRCUIT



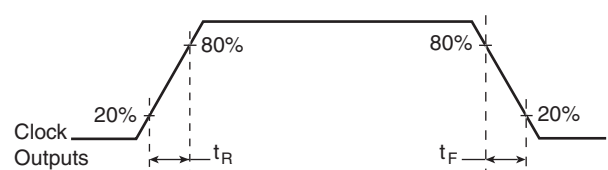
PROPAGATION DELAY



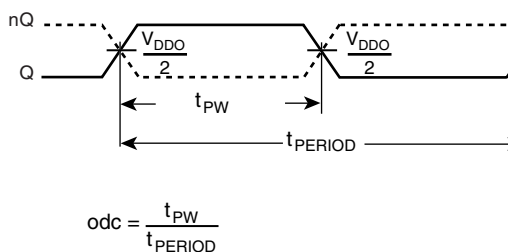
OUTPUT SKEW



PART-TO-PART SKEW



OUTPUT RISE/FALL TIME



OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD



RELIABILITY INFORMATION

TABLE 5. θ_{JA} VS. AIR FLOW TABLE FOR 8 LEAD SOIC

θ_{JA} by Velocity (Linear Feet per Minute)			
	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	153.3°C/W	128.5°C/W	115.5°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	112.7°C/W	103.3°C/W	97.1°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TRANSISTOR COUNT

The transistor count for ICS8302I-01 is: 322



Integrated
Circuit
Systems, Inc.

ICS8302I-01

Low SKEW, 1-TO-2 LVCMOS / LVTTTL
FANOUT BUFFER W/ COMPLEMENTARY OUTPUT

PACKAGE OUTLINE - SUFFIX M FOR 8 LEAD SOIC

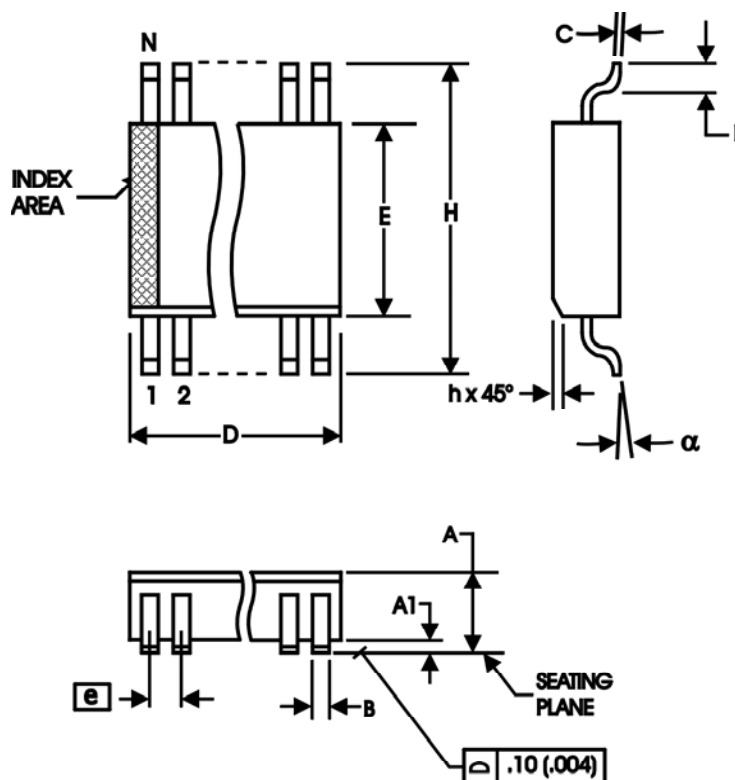


TABLE 6. PACKAGE DIMENSIONS

SYMBOL	Millimeters	
	MINIMUM	MAXIMUM
N	8	
A	1.35	1.75
A1	0.10	0.25
B	0.33	0.51
C	0.19	0.25
D	4.80	5.00
E	3.80	4.00
e	1.27 BASIC	
H	5.80	6.20
h	0.25	0.50
L	0.40	1.27
α	0°	8°

Reference Document: JEDEC Publication 95, MS-012



Integrated
Circuit
Systems, Inc.

ICS8302I-01

LOW SKEW, 1-TO-2 LVCMOS / LVTTTL

FANOUT BUFFER W/ COMPLEMENTARY OUTPUT

TABLE 7. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
ICS8302AMI-01	302AI01	8 lead SOIC	tube	-40°C to 85°C
ICS8302AMI-01T	302AI01	8 lead SOIC	2500 tape & reel	-40°C to 85°C
ICS8302AMI-01LF	302AI01L	8 lead "Lead-Free" SOIC	tube	-40°C to 85°C
ICS8302AMI-01LFT	302AI01L	8 lead "Lead-Free" SOIC	2500 tape & reel	-40°C to 85°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

The aforementioned trademark, HiPerClockS is a trademark of Integrated Circuit Systems, Inc. or its subsidiaries in the United States and/or other countries. While the information presented herein has been checked for both accuracy and reliability, Integrated Circuit Systems, Incorporated (ICS) assumes no responsibility for either its use or for infringement of any patents or other rights of third parties, which would result from its use. No other circuits, patents, or licenses are implied. This product is intended for use in normal commercial and industrial applications. Any other applications such as those requiring high reliability or other extraordinary environmental requirements are not recommended without additional processing by ICS. ICS reserves the right to change any circuitry or specifications without notice. ICS does not authorize or warrant any ICS product for use in life support devices or critical medical instruments.